

Features

- Top view 1016 package
- Viewing Angle = ±60°
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Blue
- RoHS compliance

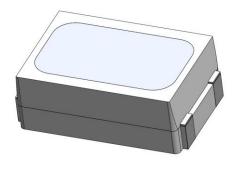
Applications

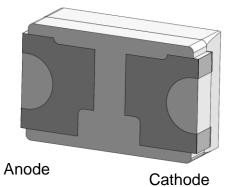
- Optical indicator.
- Switch and Symbol Display.

Description

The BC101606-ATC4 InGaN Blue LED housed in a miniature SMD package. The device has a dominant wavelength of 470 nm LED.

Package Outline





Schematic

Cathode
$$-$$
 Anode $(-)$



Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
l _F	Continuous Forward Current	30	mA	
I _{FP}	Peak Forward Current	120	mA	1
V _R	Reverse Voltage	5	V	
Topr	Operating Temperature	-40 ~ +85	°C	
T _{stg}	Storage Temperature	-40 ~ +100	°C	
T _{sol}	Soldering Temperature	260	оС	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	120	mW	

Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

Optical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I _F =20mA	225	ı	565	mcd	3
λd	Dominant Wavelength	I _F =20mA	460	-	475	nm	4
θ1/2	Angle of Half Intensity	I _F =20mA	-	±60	-	deg	

Electrical Characteristics

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I _F =20mA	2.75	-	3.65	V	5
I _R	Reverse Current	V _R =5V	-	-	1	μA	

Notes:

- 1. Tolerance of Luminous Intensity ±10%.
- 2. Tolerance of Dominant Wavelength: ±1nm.
- 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition	
S2	225	285			
T1	285	360	mad	1 20m A	
T2	360	450	mcd	I _F =20mA	
U1	450	565			



4. Bin Range of Dominant Wavelength

Bin Code	Min	Max	Unit	Condition
A5	460	465		
A6	465	470	nm	I _F =20mA
A7	470	475		

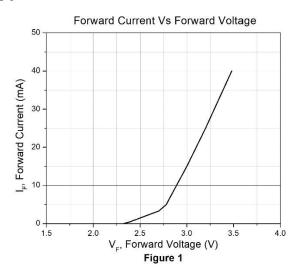
5. Bin Range of Forward Voltage

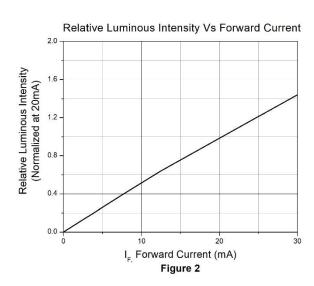
Bin Code	Min	Max	Unit	Condition
5	2.75	3.05		
6	3.05	3.35	V	I _F =20mA
7	3.35	3.65		

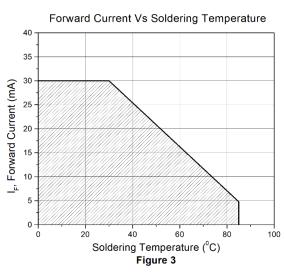
Tolerance of Forward Voltage: ±0.1V.

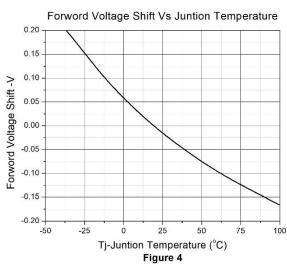


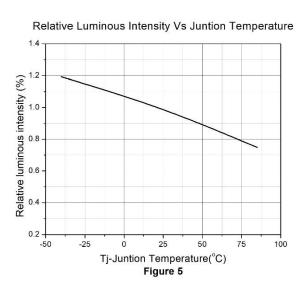
Typical Characteristic Curves

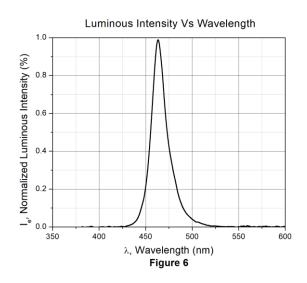








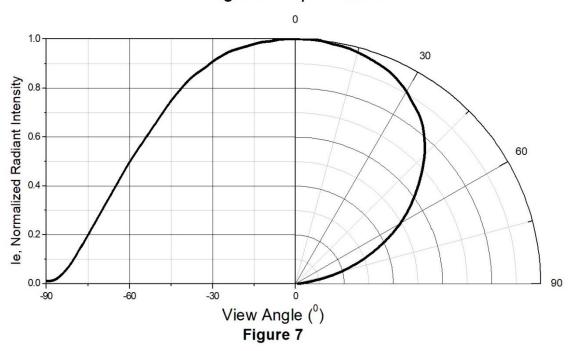






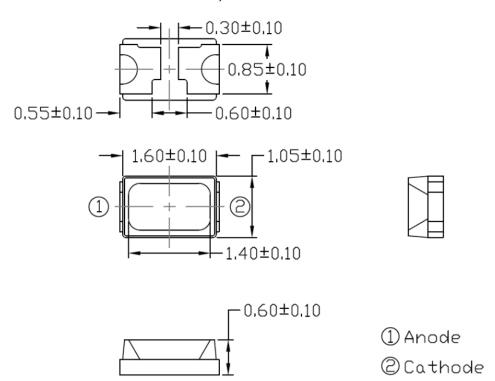
Typical Characteristic Curves

Angular Displacement



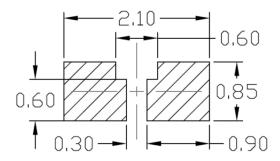


Package Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm

Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



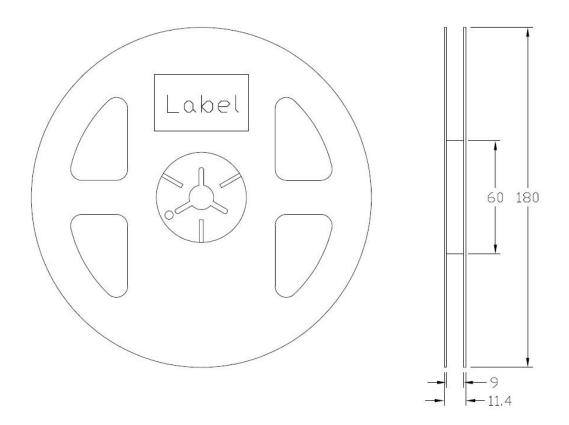
Note: Tolerance unless mentioned is ±0.1mm

Ordering Information

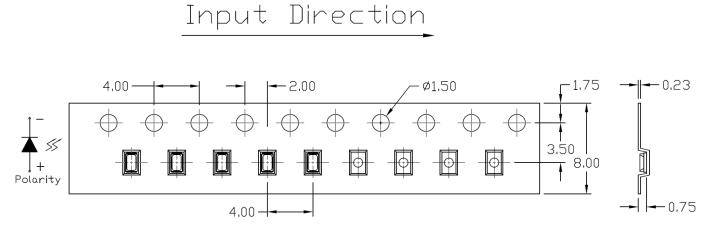
Part Number	Description	Quantity
BC101606-ATC4	Tape & Reel	4000 pcs



Reel Dimension All dimensions are in mm, unless otherwise stated



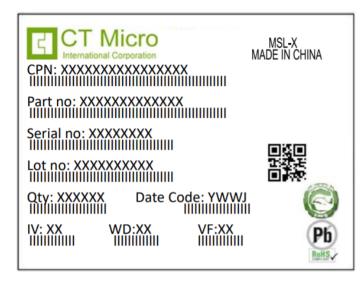
Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm



Label Form Specification



CPN : Customer Part Number Part no: CTM Production Number

Serial no: Production Number

Lot no: Lot number

Q'ty: Packing Quantity

Date Code: Manufacture Date

IV: Bin Code of Luminous Intensity

WD : Bin Code of Dominant Wavelength

VF : Bin Code of Forward Voltage

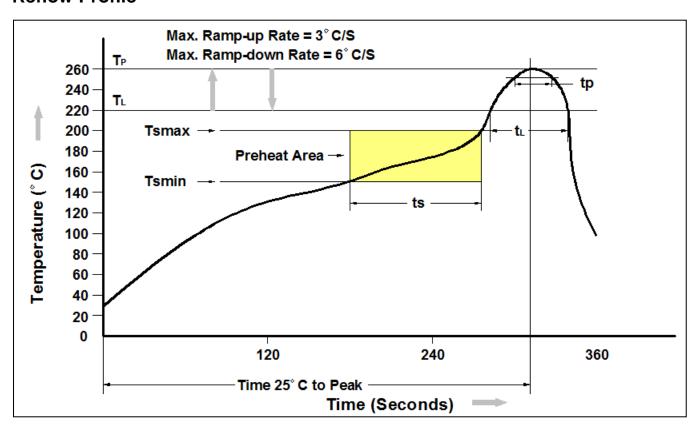
MADE IN CHINA: Production Place

Storage Condition

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



Reflow Profile



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T _L)	217°C
Time (t _L) Maintained Above (T _L)	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t _P) within 5°C of 260°C	30 seconds
Ramp-down Rate (T _P to T _L)	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.

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- A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.